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Renesas Electronics website: http://www.renesas.com

April 1<sup>st</sup>, 2010 Renesas Electronics Corporation

Issued by: Renesas Electronics Corporation (http://www.renesas.com)

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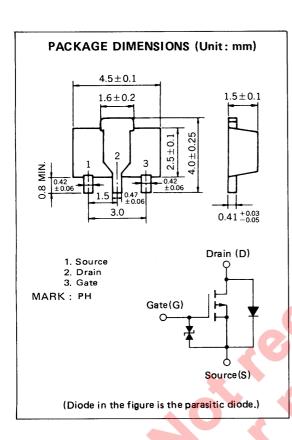
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# MOS FIELD EFFECT TRANSISTOR 2SJ206

# P-CHANNEL MOS FET FOR SWITCHING



The 2SJ206, P-channel vertical type MOS FET, is a switching device which can be driven directly by the output of ICs having a 5 V power source.

As the MOS FET has low on-state resistance and excellent switching characteristics, it is suitable for driving actuators such as motors, relays, and solenoids.

#### **FEATURES**

- Directly driven by ICs having a 5 V power supply.
- Has low on-state resistance

$$R_{DS(on)} = 4.0 \Omega MAX$$
. @ $V_{GS} = -4.0 V$ ,  $I_D = -0.3 A$   
 $R_{DS(on)} = 3.0 \Omega MAX$ . @ $V_{GS} = -10 V$ ,  $I_D = -0.3 A$ 

#### **QUALITY GRADE**

Standard

Please refer to "Quality grade on NEC Semiconductor Devices" (Document number IEI-1209) published by NEC Corporation to know the specification of quality grade on the devices and its recommended applications.

#### ABSOLUTE MAXIMUM RATINGS (Ta = 25 °C)

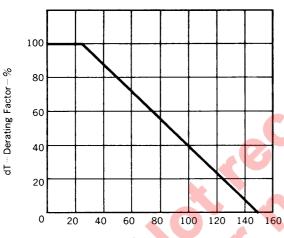
PARAMETER	SYMBOL	RATINGS	UNIT	TEST CONDITIONS
Drain to Source Voltage	V <sub>DSS</sub>	-30	V	V <sub>GS</sub> = 0
Gate to Source Voltage	V <sub>GSS</sub>	∓20	V	V <sub>DS</sub> = 0
Drain Current	ID(DC)	∓500	mA	
Drain Current	I <sub>D(pulse)</sub>	∓1.0	Α	PW ≦ 10 ms, Duty Cycle ≦ 50 %
Total Power Dissipation	PT	2.0	w	When using ceramic board of 16 cm <sup>2</sup> x 0.7 mm
Channel Temperature	T <sub>ch</sub>	150	°c	
Storage Temperature	T <sub>stg</sub>	-55 to +150	°C	

#### ELECTRICAL CHARACTERISTICS (T<sub>a</sub> = 25 °C)

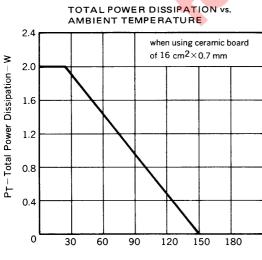
PARAMETER	SYMBOL	MIN.	TYP.	MAX.	UNIT	TEST CONDITIONS	
Drain Cut-off Current	IDSS			-1.0	μΑ	$V_{DS} = -30 \text{ V, } V_{GS} = 0$	
Gate Leakage Current	IGSS			∓5	μА	V <sub>GS</sub> = ∓16 V, V <sub>DS</sub> = 0	
Gate Cut-off Voltage	V <sub>GS(off)</sub>	-1.0	-2.3	-3.0	V	$V_{DS} = -5 \text{ V, } I_{D} = -1 \text{ mA}$	
Forward Transfer Admittance	lyfs	0.4			S	$V_{DS} = -5 V I_{D} = -0.3 A$	
Drain to Source On-State Resistance	R <sub>DS(on)1</sub>		2.0	4.0	Ω	V <sub>GS</sub> = -4.0 V, I <sub>D</sub> = -0.3 A	
Drain to Source On-State Resistance	RDS(on)2		0.8	3.0	Ω	$V_{GS} = -10 \text{ V, } I_D = -0.3 \text{ A}$	
Input Capacitance	Ciss		100		pF		
Output Capacitance	Coss		80		pF	$V_{DS} = -5 \text{ V}, V_{GS} = 0, f = 1 \text{ MHz}$	
Feedback Capacitance	C <sub>rss</sub>		15		pF		
Turn-On Delay Time	<sup>t</sup> d(on)		120		ns		
Rise Time	tr		420		ns	$V_{GS(on)} = -4 \text{ V, R}_{G} = 10 \Omega, V_{DD} = -5 \text{ V,}$	
Turn-Off Delay Time	<sup>t</sup> d(off)		75		ns	$I_D = -0.3$ A, $R_L = 17 \Omega$	
Fall Time	tf		140		ns		

#### TYPICAL CHARACTERISTICS ( $T_a = 25$ °C)



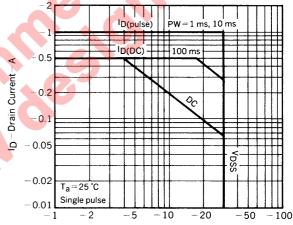


T<sub>C</sub> - Case Temperature - °C



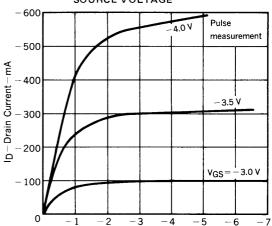
Ta-Ambient Temperature-°C

## FORWARD BIAS SAFE OPERATING AREA

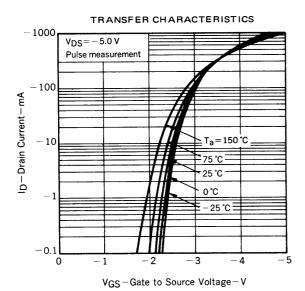


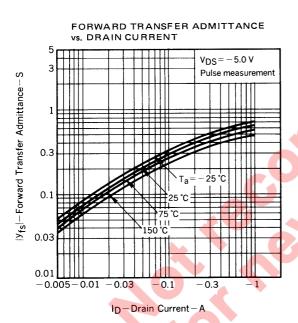
V<sub>DS</sub>-Drain to Source Voltage-V

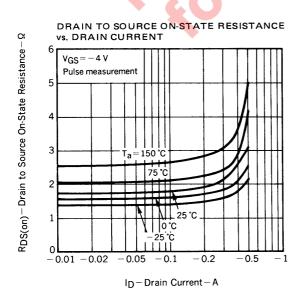
# DRAIN CURRENT vs. DRAIN TO SOURCE VOLTAGE

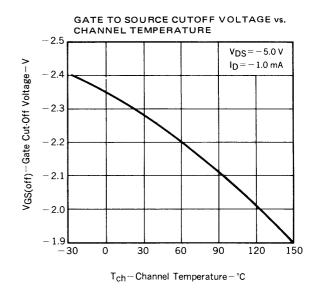


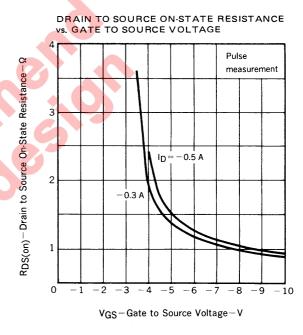
 $V_{DS}\!-\!Drain\ to\ Source\ Voltage\!-\!V$ 

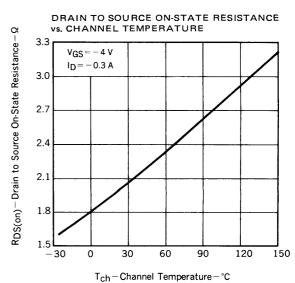


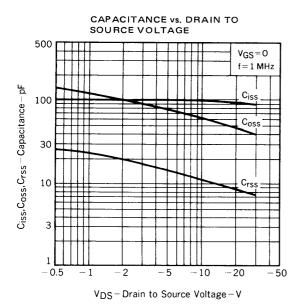


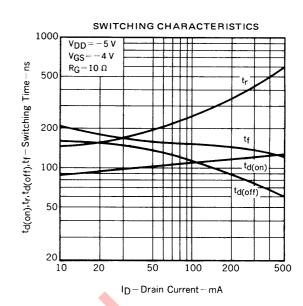


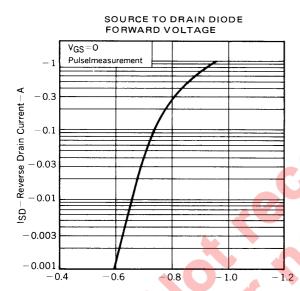






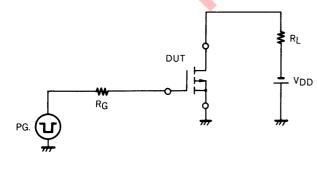


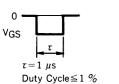


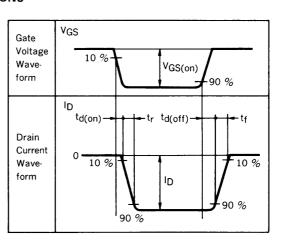


#### SWITCHING TIME MEASUREMENT CIRCUIT AND CONDITIONS

VSD-Source to Drain Voltage-V









#### RECOMMENDED SOLDERING CONDITIONS

Mounting of this product by soldering should be done under the following conditions.

Please consult with our representatives about soldering methods and conditions other than these recommended.

#### **SURFACE MOUNT TYPE**

For details of the recommended soldering conditions, see the information document.

"Device Mounting Manual for Surface Mounting (IEI-1207)."

Soldering Method	Soldering Conditions	Symbol for Recommended Conditions
Infrared Reflow	Package peak temp.: 230 °C Soldering time: within 30 sec (above 210 °C) Soldering times: 1, Days limitation: none*	IR30-00
Vapor Phase Soldering	Package peak temp.: 215 °C Soldering time: within 40 sec (above 200 °C) Soldering times: 1, Days limitation: none*	VP15-00
Wave Soldering	Soldering bath temp.: below 260 °C Soldering time: within 10 sec Soldering times: 1, Days limitation: none*	WS60-00

<sup>\*</sup> Stored days under storage conditions at 25 °C and below 65 % R.H. after dry-pack opened.

Note 1: Combination of soldering methods should be avoided.

#### REFERENCE

Document Name	Document No.
NEC semiconductor device reliability/quality control system.	TEI-1202
Quality grade on NEC semiconductor devices.	IEI-1209
Semiconductor device mounting technology manual.	IEI-1207
Semiconductor device package manual.	IEI-1213
Guide to quality assurance for semiconductor devices.	MEI-1202
Semiconductor selection guide.	MF-1134

(MEMO)



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